korney's Docket No. LAM2P216

As a below-named inventor, I hereby declare that:

(check one)

My residence, post office address and citizenship are as stated below next to my name.

is attached hereto.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: WAFER BACKSIDE PLATE FOR USE IN A SPIN, RINSE, AND DRY MODULE AND METHODS FOR MAKING AND IMPLEMENTING THE SAME, the specification of which,

	<b>2</b> □	51ad an		os.
2 was filed on U.S. Application Serial No.				
		<del></del>	NO	
		and was amended on		<del>•</del> •
	3. 🔲	was filed on	·····	as
		International PCT Appl	ication Serial No.	
**************************************		and was amended on	·	
I hereby state that I ha			ontents of the above-identi	fied specification, including the claims, as
amended by any amend	ment referre	ed to above.		
Testeroulodge the duty	to disalosa	information which is m	starial to the exemination	of this application in accordance with Title
37, CFR § 1.56.	to disclose	information which is in	aterial to the examination	of this application in accordance with The
J/, CIR § 1.50.				
I hereby claim foreign	priority ben	efits under Title 35, Uni	ted States code, § 119(a)-(	d) or § 365(b) of any foreign application(s)
				which designated at least one country other
F 4 75				box, any foreign application for patent or
			•	hat of the application on which priority is
clatined:				
or the state of th				
Prior Foreign Application	tion(s)			Priority Benefits Claimed?
	<del></del>			Yes No
(Appl. No.)		(Country)	(Filing Date)	
				YesNo
(Appl. No.)		(Country)	(Filing Date)	
				Yes No
(A1 N- )		(Country)	(Filing Data)	
(Appl. No.)		(Country)	(Filing Date)	
I hereby claim the benef	fit under 35	IISC 8119(e) of any II	nited States provisional app	olication(s) listed below:
increby claim ale conc.	in dildoi 55	0.5.C. \$115(b) of may 0	into outros provisionas app	,,
			<u></u>	
(Application Serial No.)	)	(Filing Date)		
· • •		• •		
(Application Serial No.)	)	(Filing Date)		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S. Application(s	s) <b>(</b>	•			
(Application Serial No.)		ing Date)	(Status - patented, pending, abandoned)		
(Application Serial No.)		ing Date)	(Status - patented, pending, abandoned)		
(Reg. No. 39,487); Rayr No. 46,938); Joe A. Bro	nis H. Kim (Reg. No. 3 ock II (Reg. No. 46,02 randt (Reg. No. 39,119	39,462); Chester E. M 21); Rick von Wohld D), of Lam Research	In Peter B. Martine (Reg. No. 32,043); Albert S. Penilla Martine (Reg. No. 19,711); Edmund H. Mizumoto (Reg. (Reg. No. P-48,018); and Jeffrey J. Brooks (Reg. No. Corporation, as my principal attorneys to prosecute this lice connected therewith:		
Send Correspondence To:		Albert S. Penilla			
		RTINE PENILL	·		
		710 Lakeway Drive, Suite 170			
		Sunnyvale, CA 94085			
		Customer Number 25920			
Direct Telephone Calls To:		Albert S. Penilla at telephone number (408) 749-6903			
<del></del>	statements made herein	of my own knowledge	e are true and that all statements made on information and		
			de with the knowledge that willful false statements and the		
-	-		ection 1001 of Title 18 of the United States Code, and that on or any patent issuing thereon.		
	nes may jeopardize die v	andity of the applicat	on or any patent issuing thereon.		
Typewritten Full Name o					
Sole or First Inventor: Stephen M. Smi			Citizenship: USA		
Inventor's signature:		ha-	Date of Signature: 12/2//03		
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Inventor's signature:

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Date of Signature:\_\_

(State/Country)